



ER3442A

100V N-Channel MOSFET

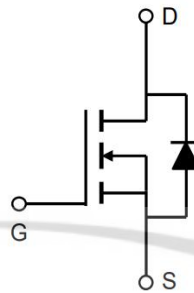
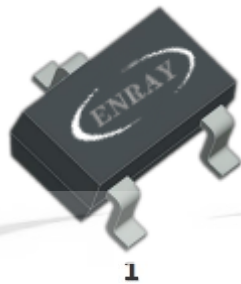
Features

The ER3442A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

Product Summary

V_{DS}	100V
I_D	2A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 380m Ω
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 450m Ω

- 1.GATE
- 2.SOURCE
- 3.DRAIN



Order Information

Product	Package	Marking	Packing
ER3442A	SOT-23	SA34	3000PCS/Reel

Maximum Ratings(Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	1	A
Pulsed Drain Current ①	I_{DM}	4	
Continuous Source-Drain Current(Diode Conduction)	I_S	1	
Power Dissipation ②	PD	1.4	W
Thermal Resistance from Junction to Ambient (t \leq 5s)	$R_{\theta JA}$	125	$^{\circ}C/W$
Operating Junction	T_J	150	$^{\circ}C$
Storage Temperature	T_{STG}	-55~+150	$^{\circ}C$



Electrical Characteristics(T_J=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Parameters ③						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250μA	100			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1		2.9	V
Gate-Body leakage Current	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0V			1	μA
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 1A		300	380	mΩ
		V _{GS} = 4.5V, I _D = 0.8A		350	450	mΩ
Forward Transconductance	g _{Fs}	V _{DS} = 5V, I _D = 1 A		2.8		S
Diode Forward Voltage	V _{SD}	I _S = 1A, V _{GS} = 0V		0.8	1.2	V
Dynamic Parameters ④						
Input Capacitance	C _{iss}	V _{DS} = 50V, V _{GS} = 0V, f = 1MHz		100		pF
Output Capacitance	C _{oss}			13		pF
Reverse Transfer Capacitance	C _{rss}			5		pF
Total Gate Charge	Q _g	V _{DS} = 50V, V _{GS} = 10V, I _D = 1A		2.8		nC
Gate Source Charge	Q _{gs}			0.4		nC
Gate Drain Charge	Q _{gd}			0.8		nC
Gate Resistance	R _g	f = 1MHz		5		Ω
Switching Parameters ④						
Turn-On DelayTime	t _{d(on)}	V _{DS} = 50V R _L = 50Ω, I _D = 1A, V _{GS} = 10V, R _g = 3Ω		5		ns
Turn-On Rise Time	t _r			4		ns
Turn-Off DelayTime	t _{d(off)}			12		ns
Turn-Off Fall Time	t _f			5		ns

Note :

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t < 5 sec.
3. Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.

Typical Electrical and Thermal Characteristics

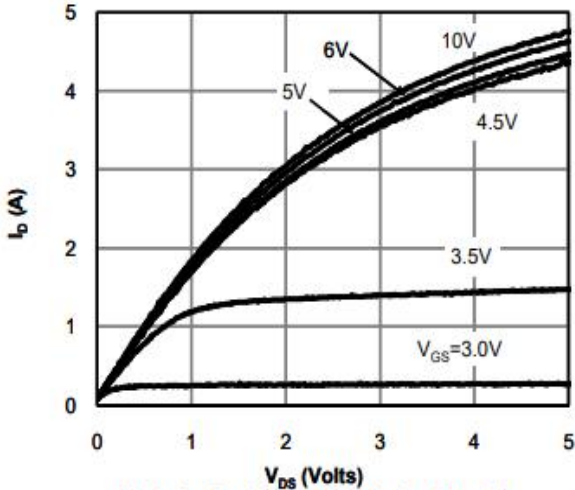


Fig 1: On-Region Characteristics (Note E)

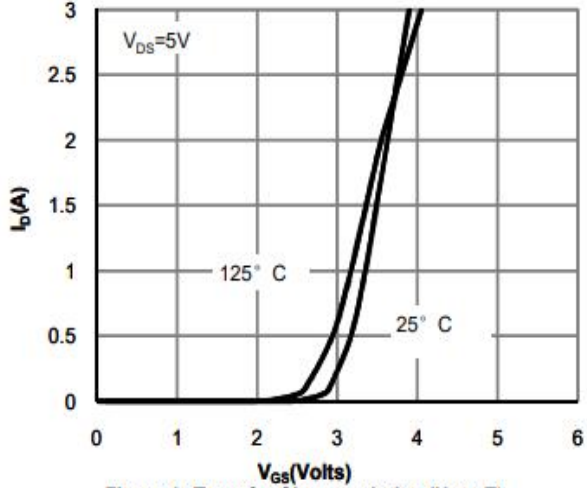


Figure 2: Transfer Characteristics (Note E)

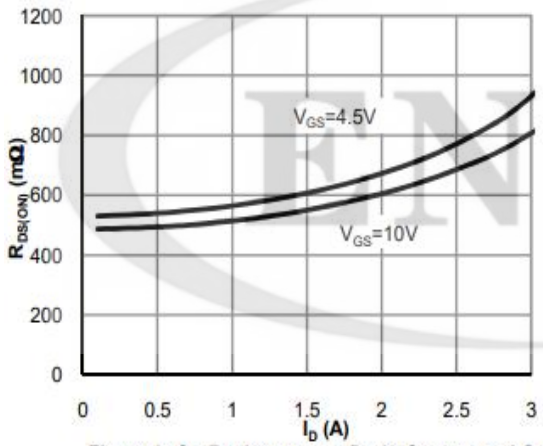


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

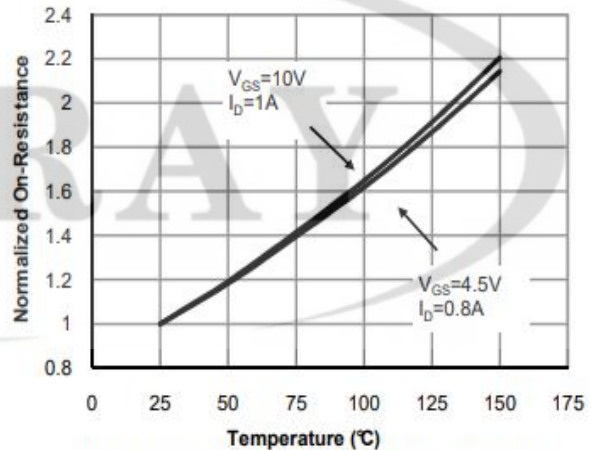


Figure 4: On-Resistance vs. Junction Temperature (Note E)

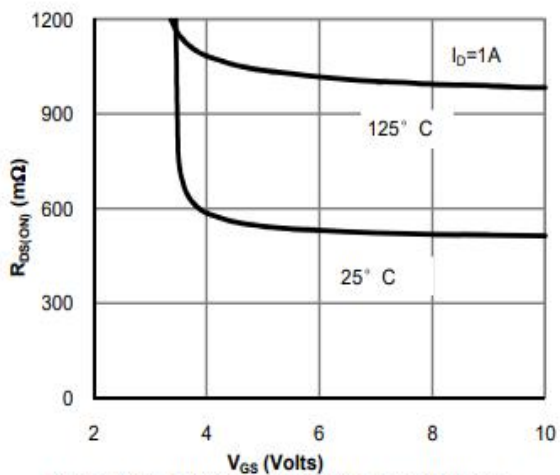


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

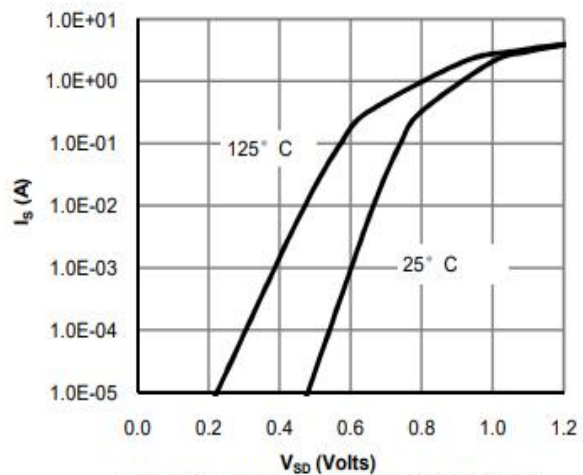


Figure 6: Body-Diode Characteristics (Note E)

Typical Electrical and Thermal Characteristics

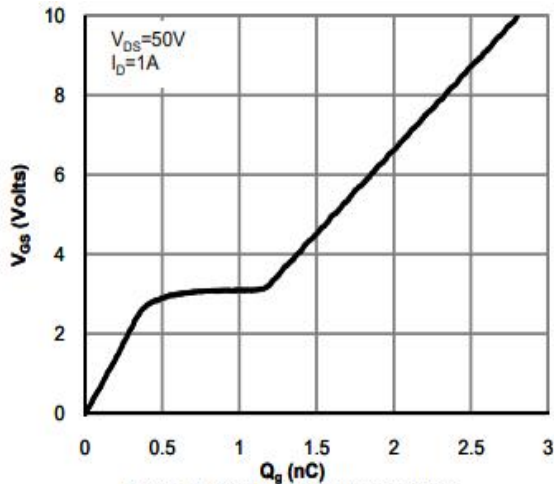


Figure 7: Gate-Charge Characteristics

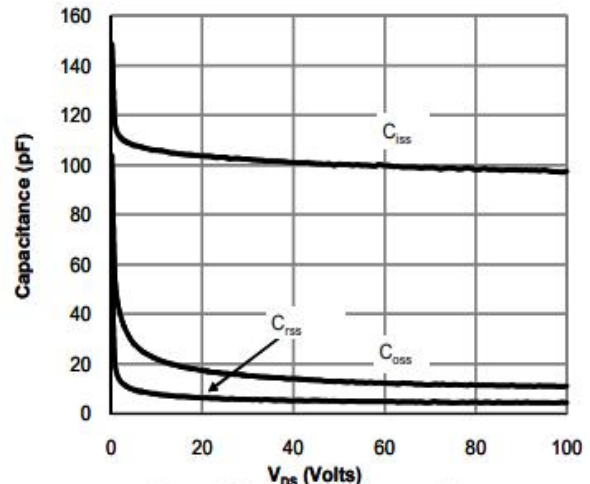


Figure 8: Capacitance Characteristics

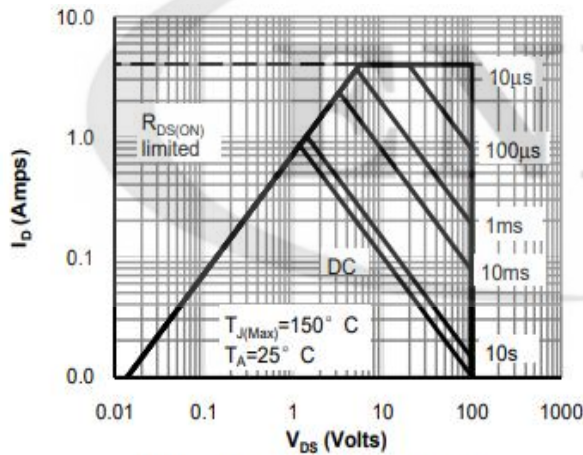


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

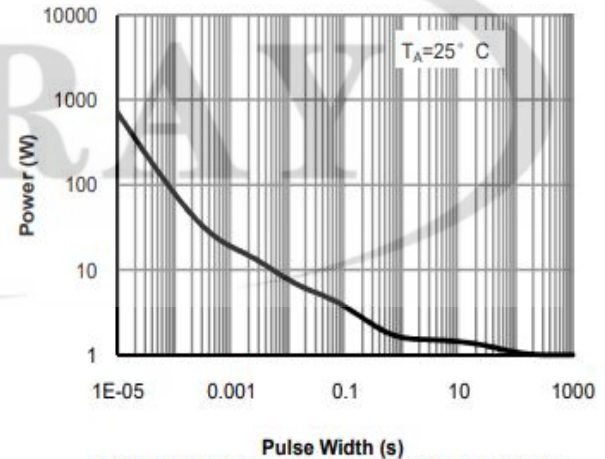


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

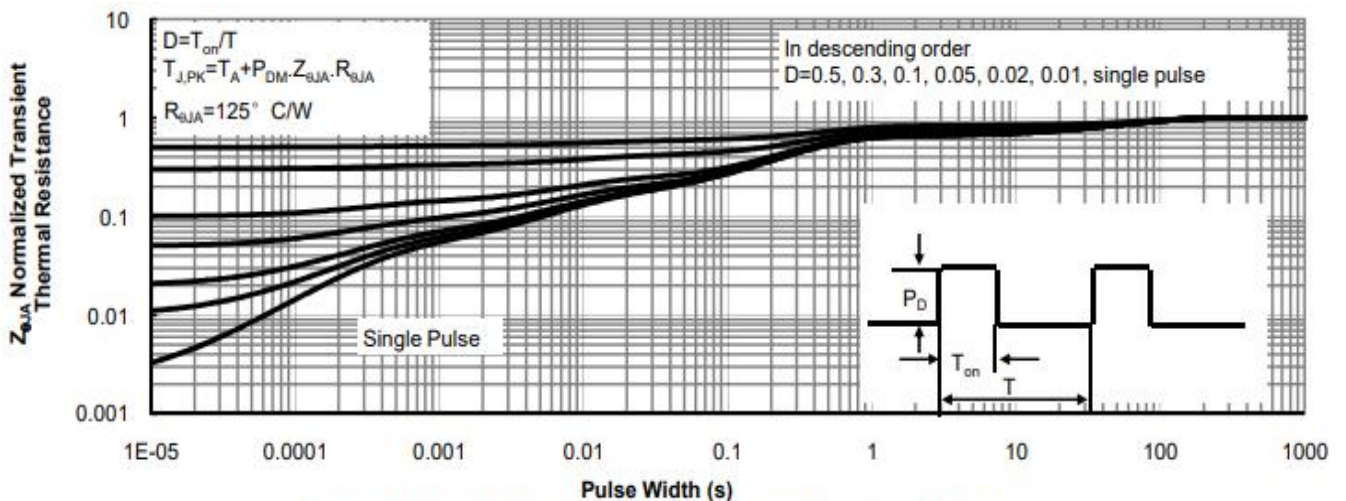
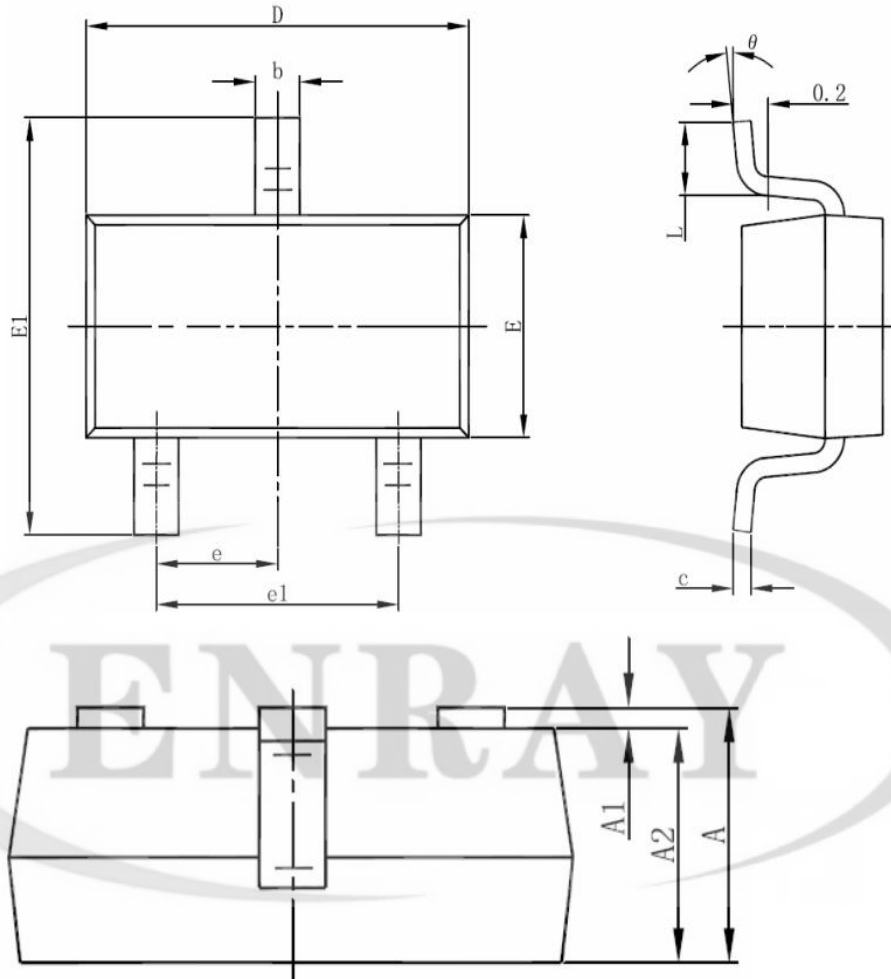


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

SOT-23-3L Package Outline Dimesions


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037 (BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°